

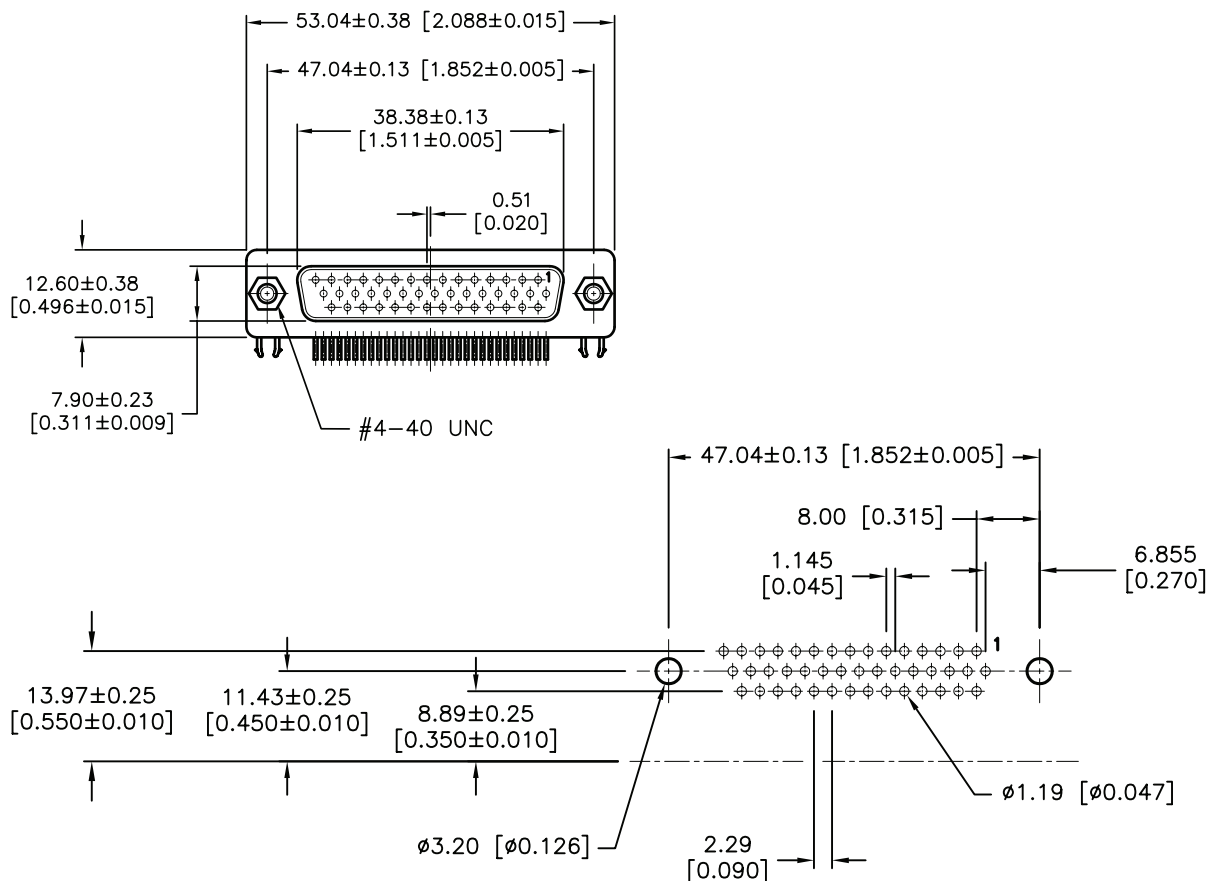
D-Sub R/A PCB Socket

44 Pin High-Density



Specifications

Shell	: Steel, Nickel-Plated over Copper
Insulator	: PBT + 30% Fiber-Glass, Black Colour
Contact	: Copper Alloy, Gold-Plated on Contact Area Tin-Plated on Dip Solder Tail
Rivet	: Metal, Nickel-Plated
Board-Lock	: Brass, Tin-Plated
Jack-Screw	: Brass, Nickel-Plated
Current Rating	: 2 Amps
Insulator Resistance	: 5,000MΩ Min. at 500V DC
Dielectric withstanding Voltage	: 1,000V AC Min. for One Minute
Contact Resistance	: 20mΩ Max.
Working Temperature	: -55°C to +105°C

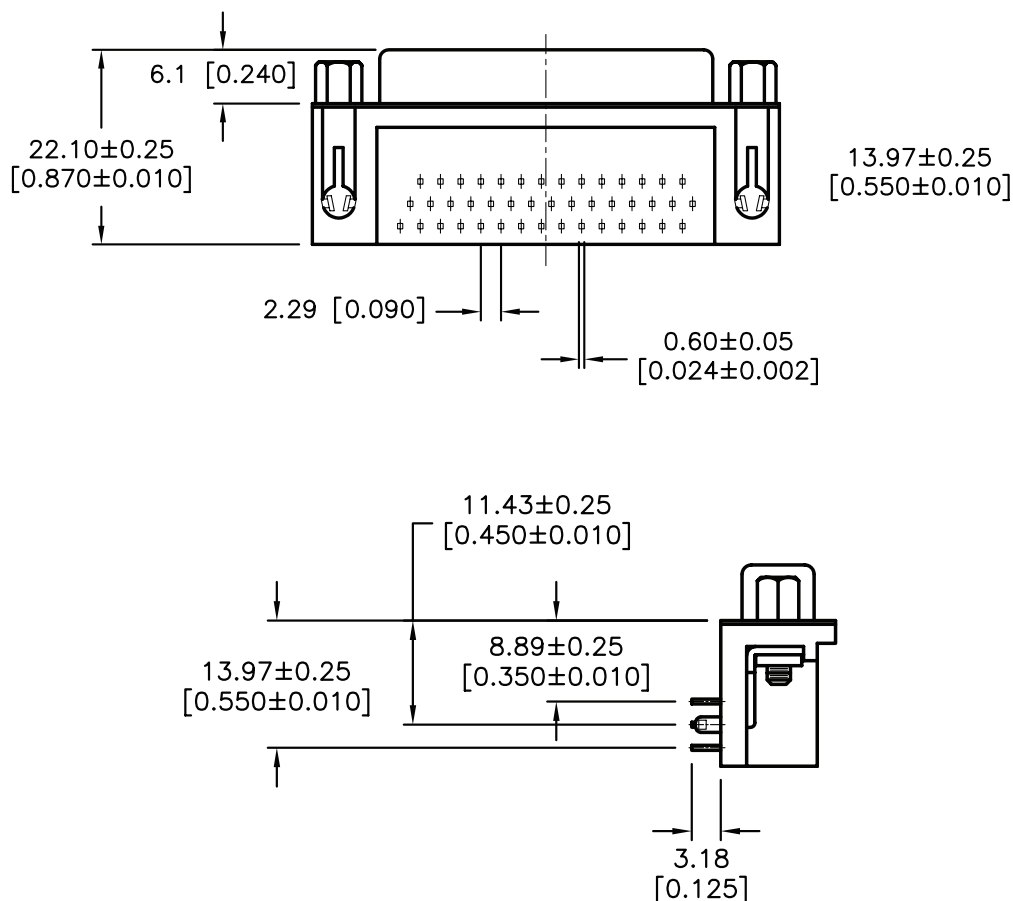


Panel Cutout

Dimensions : Millimeters (Inches)

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Dimensions : Millimeters (Inches)

Part Number Table

Description	Part Number
44 Pin High-Density D-Sub R/A PCB Socket	SPC15324

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